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APPLICATION NUMBER	FILING OR 371(c) DATE	FIRST NAMED APPLICANT	ATTY. DOCKET NO./TITLE
10/562,235	10/30/2006	Syouji Nogami	JG-SU-5224/500577.20073

**CONFIRMATION NO. 8539**

26418  
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**Title:** Manufacturing method of semiconductor wafer and semiconductor wafer manufactured by this method

**Publication No.** US-2007-0128836-A1

**Publication Date:** 06/07/2007

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